

1200V, 70A,  $V_{ce(on)}$  = 2.5V Typical

# Ultra Fast NPT - IGBT®

The Ultra Fast NPT - IGBT® is a new generation of high voltage power IGBTs. Using Non-Punch-Through Technology, the Ultra Fast NPT-IGBT® offers superior ruggedness and ultrafast switching speed.

# TO-247 Max TO-264

#### **Features**

- · Low Saturation Voltage
- Low Tail Current
- RoHS Compliant

- · Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current

Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).



#### **MAXIMUM RATINGS**

All Ratings: I	$_{\rm C}$ = 25°C unless of	therwise specified.

Symbol	Parameter	Ratings	Unit
V <sub>ces</sub>	Collector Emitter Voltage	1200	V
V <sub>GE</sub>	Gate-Emitter Voltage	±30	ľ
I <sub>C1</sub>	Continuous Collector Current @ T <sub>C</sub> = 25°C	160	
I <sub>C2</sub>	Continuous Collector Current @ T <sub>C</sub> = 110°C	70	Α
I <sub>CM</sub>	Pulsed Collector Current ①	280	
SCWT	Short Circuit Withstand Time: V <sub>CE</sub> = 600V, V <sub>GE</sub> = 15V, T <sub>C</sub> =125°C	10	μs
P <sub>D</sub>	Total Power Dissipation @ T <sub>c</sub> = 25°C	961	W
T <sub>J</sub> ,T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to 150	°C
T <sub>L</sub>	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	

#### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Max	Unit
V <sub>(BR)CES</sub>	Collector-Emitter Breakdown Voltage (V <sub>GE</sub> = 0V, I <sub>C</sub> = 1.0mA)	1200			
V <sub>GE(TH)</sub>	Gate Threshold Voltage $(V_{CE} = V_{GE}, I_{C} = 2.5 \text{mA}, T_{j} = 25 ^{\circ}\text{C})$	3.5	5.0	6.5	., .,
	Collector-Emitter On Voltage $(V_{GE} = 15V, I_C = 70A, T_j = 25^{\circ}C)$	ĺ	2.5	3.2	Volts
$V_{CE(ON)}$	Collector-Emitter On Voltage (V <sub>GE</sub> = 15V, I <sub>C</sub> = 70A, T <sub>j</sub> = 125°C)		3.3		1
	Collector-Emitter On Voltage (V <sub>GE</sub> = 15V, I <sub>C</sub> = 140A, T <sub>j</sub> = 25°C)		3.5		1
I <sub>ces</sub>	Collector Cut-off Current (V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0V, T <sub>j</sub> = 25°C) ②		10	1000	μA
CES	Collector Cut-off Current (V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0V, T <sub>j</sub> = 125°C) (2)		100		
I <sub>GES</sub>	Gate-Emitter Leakage Current (V <sub>GE</sub> = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

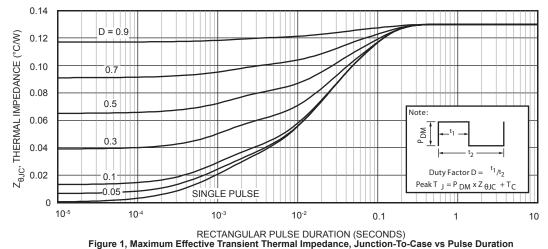
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C <sub>ies</sub>	Input Capacitance	Capacitance		7260		
C <sub>oes</sub>	Output Capacitance	$V_{GE} = 0V, V_{CE} = 25V$		643		pF
C <sub>res</sub>	Reverse Transfer Capacitance	f = 1MHz		199		
$V_{GEP}$	Gate to Emitter Plateau Voltage	Cata Charas		7.5		V
Q <sup>3</sup>	Total Gate Charge	Gate Charge		412	544	
$Q_{ge}$	Gate-Emitter Charge	V <sub>GE</sub> = 15V		48	62	0
$Q_{gc}$	Gate- Collector Charge	$V_{CE} = 600V$ $I_{C} = 70A$		204	275	nC
t <sub>d(on)</sub>	Turn-On Delay Time	Inductive Switching (25°C)		33		
t <sub>r</sub>	Current Rise Time	V <sub>cc</sub> = 600V		48		20
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GE</sub> = 15V		278		ns
t <sub>f</sub>	Current Fall Time	I <sub>C</sub> = 70A		64		
E <sub>on2</sub> ⑤	Turn-On Switching Energy	$R_{_{\rm G}} = 4.3  \Omega^{(4)}$		3816	5720	1
E <sub>off</sub>	Turn-Off Switching Energy	T <sub>J</sub> = +25°C		2582	3870	μJ
t <sub>d(on)</sub>	Turn-On Delay Time	Inductive Switching (125°C)		33		
t <sub>r</sub>	Current Rise Time	V <sub>cc</sub> = 600V		48		
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GE</sub> = 15V		320		ns
t <sub>f</sub>	Current Fall Time	I <sub>C</sub> = 70A		74		
E <sub>on2</sub>	Turn-On Switching Energy	$R_{\rm G} = 4.3  \Omega^{(4)}$		5651	8475	1
E <sub>off</sub>	Turn-Off Switching Energy	T <sub>J</sub> = +125°C		3323	4980	μJ

#### THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Symbol Characteristic		Min	Тур	Max	Unit
$R_{\theta JC}$	Junction to Case Thermal Resistance (IGBT)				.13	°C/W
$R_{\theta JA}$	Junction to Ambient Thermal Resistance				40	C/VV
W <sub>T</sub>	Package Weight -	B2		.22		oz
				6		g
		L		.36		oz
				10		g

- 1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.
- 2 Pulse test: Pulse Width < 380 $\mu$ s, duty cycle < 2%.
- 3 See Mil-Std-750 Method 3471.
- 4  $R_{\rm g}$  is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)
- 5 E<sub>on2</sub> is the clamped inductive turn on energy that includes a commutating diode reverse recovery current in the IGBT turn on energy loss. A combi device is used for the clamping diode.

 $6~E_{\rm off}^{-1}$  is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1. Microsemi reserves the right to change, without notice, the specifications and information contained herein.



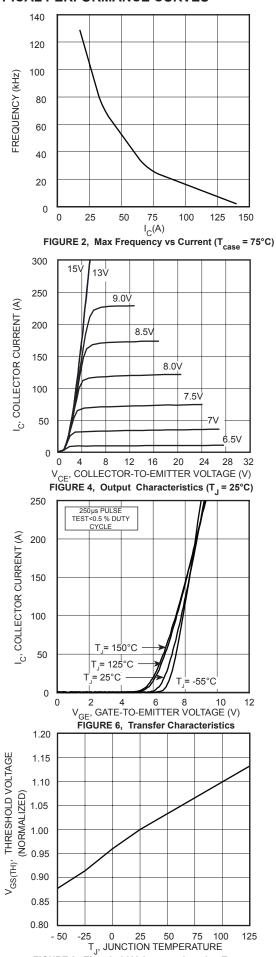


FIGURE 8, Threshold Voltage vs Junction Temperature

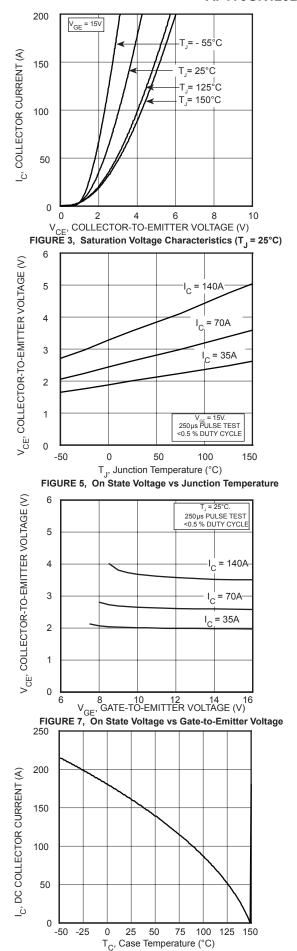


FIGURE 9, DC Collector Current vs Case Temperature

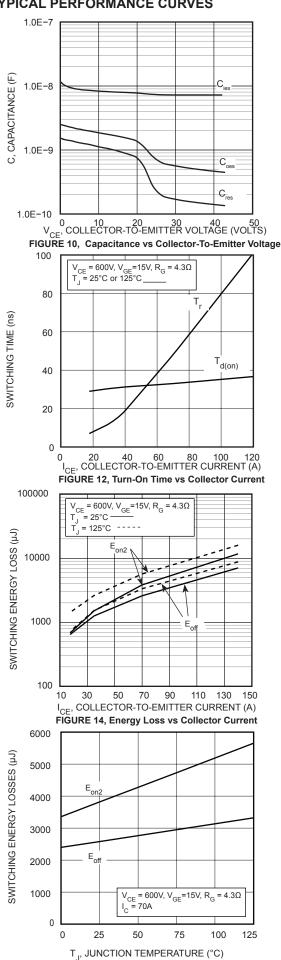


FIGURE 16, Swiitching Energy vs Junction Temperature

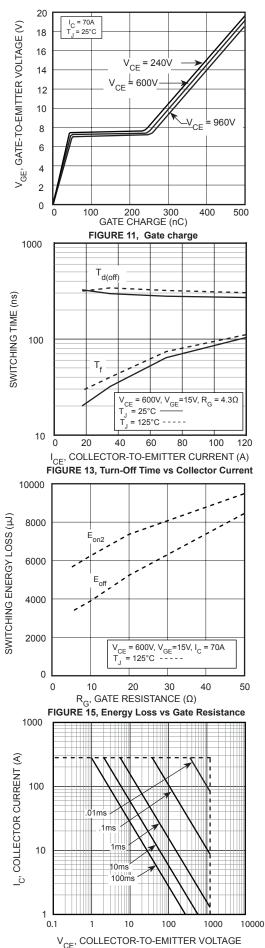


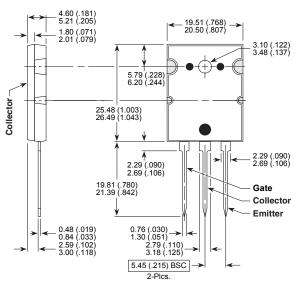
FIGURE 17, Minimum Switching Safe Operating Area

### T-MAX™ (B2) Package Outline

## 4.69 (.185) 5.31 (.209) 15.49 (.610) 16.26 (.640) 1.49 (.059) 2.49 (.098) 5.38 (.212) 6.20 (.244) Collector 20.80 (.819) 21.46 (.845) 2.87 (.113) 3.12 (.123) 4.50 (.177) Max. 19.81 (.780) 20.32 (.800) 1.40 (.055) 1.65 (.065) 2.13 (.084) Gate Collector Emitter 2.21 (.087) 2.59 (.102) 5.45 (.215) BSC 2-Plcs

# These dimensions are equal to the TO-247 without the mounting hole. Dimensions in Millimeters and (Inches)

## TO-264 (L) Package Outline



Dimensions in Millimeters and (Inches)

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